

First, anodes 2a to 2g are formed on a substrate 1, and a cathode terminal 4 is simultaneously formed. Next, a hole injection layer 5 and a light-emitting layer 6 are formed over the entire surface of the substrate by spin coating. Subsequently, at a position corresponding to the cathode terminal 4, a liquid containing powdered silver and a solvent is dripped from a container 7 of a dispenser. As this solvent, a solvent that dissolves the hole injection layer 5 and the light-emitting layer 6 is used. Accordingly, a throughhole is provided at the position corresponding to the cathode terminal 4, and this throughhole is filled with silver 8. Next, a cathode layer 9 is formed so as to cover the position at which the throughhole is provided.